

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: T. Haze Attorney Docket No.: LEPA122745
Application No.: 10/823,297 Art Unit: 2822 / Confirmation No: 4560
Filed: April 13, 2004 Examiner: P.E. Perkins
Title: METHOD OF FORMING BUMP PAD OF FLIP
CHIP AND STRUCTURE THEREOF

AMENDMENT A

Seattle, Washington 98101

December 18, 2006

TO THE COMMISSIONER FOR PATENTS:

INTRODUCTORY COMMENTS

Please amend the above-identified application as follows.